PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE.

In re Application of:

Chopra et al.

Serial No.: 10/620,002

Filed: July 14, 2003

FOR: SLURRY FOR USE WITH FIXED-ABRASIVE POLISHING PADS IN POLISHING SEMICONDUCTOR DEVICE CONDUCTIVE STRUCTURES THAT INCLUDE COPPER AND A COPPER

BARRIER (as amended)

Confirmation No.: 7481

Examiner: L. Vinh

Group Art Unit: 1792

Attorney Docket No.: 2269-4373.2US (00-0036.02/US)

VIA ELECTRONIC FILING June 4, 2008

## AMENDMENT UNDER 37 C.F.R. §1.116

Mail Stop AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

This communication is being filed in response to the Final Office Action mailed on April 11, 2008, the three-month shortened statutory period for response to which expires on July 11, 2008.

This response is submitted on or before two months from the mailing date of the Final Office Action.

## Serial No. 10/620,002

Amendments to the Claims are reflected in the listing of claims, which starts at page 3 of this paper;

Remarks begin on page 7 of this paper.